

# **Final Product Change Notification**

202104008F01 : SOT552-1 Transfer from ATP-1 to ASEN

Note: This notice is NXP Company Proprietary.

Issue Date: Oct 05, 2021 Effective date: Jan 04, 2022

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### Management summary

Due to the low volume of SOT552-1 running at ATP-1, assembly will transfer from ATP-1 to ASEN. **Change Category** 

Change	Category
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Fab Process	[]Assembly Process	[]Product Marking	[]Test Process	[]Design
[ ]Wafer Fab Materials	[X]Assembly Materials	[]Mechanical Specification	[ ]Test Equipment	[]Errata
[ ]Wafer Fab Location	[X]Assembly Location	[]Packing/Shipping/Labeling	[]Test Location	[]Electrical spec./Test coverage

[]Firmware []Other

## PCN Overview Description

Due to the low volume of SOT552-1 running at ATP-1, assembly will transfer from ATP-1 to ASEN. The material set will change to the ASEN standard material set which includes a roughened (RT) leadframe. This leadframe is a quality improvement which provides superior delamination performance after customer's SMT. It should be noted that orderable part numbers will change to reflect the use of SBB (Static Barrier Bag) needed for the RT lead frame.

- Please contact Frans Voogt and Dennis Dill at the following contact points if there are questions: Frans.Voogt@nxp.com / Dennis.Dill@nxp.com

## Reason

Due to the low volumes on SOT552-1 at ATP-1, assembly will transfer from ATP-1 to ASEN. **Identification of Affected Products** 

Product identification does not change

## **Product Availability**

Sample Information Samples are available upon request Production Planned first shipment Nov 25, 2021

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality **Data Sheet Revision** A new datasheet will be issued **Disposition of Old Products** Existing inventory will be shipped until depleted **Timing and Logistics** 

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by Nov 04, 2021.

## **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name	Steve Blozis			
Position	Marketing			
e-mail address	stephen.blozis@nxp.com			

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## NXP Quality Management Team.

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High Tech Campus, 5656 AG Eindhoven, The Netherlands

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Changed Orderable Part#	12NC	Product Type	Product Description	Package Outline	Package Description	Product Status	Customer Specific Indicator	Product Line
PCF85263ATT1/AJ	935304461118	PCF85263ATT1/A	Tiny RTC with Batt switch TSSOP10	(T)SSOP10	SOT552-1	RFS	No	BLC6
PCF85263ATT1/AZ	935304461431	PCF85263ATT1/A	Tiny RTC with Batt switch TSSOP10	(T)SSOP10	SOT552-1	CQS	No	BLC6
PCF85363ATT1/AJ	935304752118	PCF85363ATT1/A	Tiny RTC Bat switch RAM I2C TSSOP10	(T)SSOP10	SOT552-1	RFS	No	BLC6
PCF85363ATT1/AZ	935304752431	PCF85363ATT1/A	Tiny RTC Bat switch RAM I2C TSSOP10	(T)SSOP10	SOT552-1	CQS	No	BLC6
PCA9527DP,118	935289105118	PCA9527DP	3channel bidirectional bus extender	(T)SSOP10	SOT552-1	RFS	No	BLC6
PCA9527DPZ	935289105431	PCA9527DP	3channel bidirectional bus extender	(T)SSOP10	SOT552-1	CQS	No	BLC6
PCA9537DP,118	935277495118	PCA9537DP	PCA9537	(T)SSOP10	SOT552-1	RFS	No	BLC6
PCA9537DPZ	935277495431	PCA9537DP	PCA9537	(T)SSOP10	SOT552-1	CQS	No	BLC6
PCA9614DP,118	935298545118	PCA9614DP	2-ch multipoint Fm+ dI2C-bus buffer	(T)SSOP10	SOT552-1	RFS	No	BLC6
PCA9614DPZ	935298545431	PCA9614DP	2-ch multipoint Fm+ dI2C-bus buffer	(T)SSOP10	SOT552-1	CQS	No	BLC6
PCA9615DPJ	935302505118	PCA9615DP	2-ch mp hot swap Fm+ dI2C-bus buffe	(T)SSOP10	SOT552-1	RFS	No	BLC6
PCA9615DPZ	935302505431	PCA9615DP	2-ch mp hot swap Fm+ dl2C-bus buffe	(T)SSOP10	SOT552-1	CQS	No	BLC6
PCA9632DP2,118	935286528118	PCA9632DP2	PCA9632	(T)SSOP10	SOT552-1	RFS	No	BLC6
PCA9632DP2Z	935286528431	PCA9632DP2	PCA9632	(T)SSOP10	SOT552-1	CQS	No	BLC6